PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ATAPOL PRAJUCKAMOL	12/02/2014
YUSHUANG YAO	12/02/2014
CHEE HIONG CHEW	12/03/2014

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC
Street Address:	5005 E. MCDOWELL ROAD
Internal Address:	MAILDROP A700
City:	PHOENIX
State/Country:	ARIZONA
Postal Code:	85008

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15945649

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	ONS01685D01US			
NAME OF SUBMITTER:	MICHELLE A. SMOJVER			
SIGNATURE:	/MICHELLE A. SMOJVER/			
DATE SIGNED:	04/04/2018			

Total Attachments: 4

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PATENT REEL: 045440 FRAME: 0217

ASSIGNMENT & AGREEMENT

ONS01685

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Name	of (City/State/Country)		
Atapol PRAJUCKAMOL	Klaeng, Rayong, Thailand		
Chee Hiong CHEW	Seremban, Negeri Sembilan, Malaysia		
Yushuang YAO	Seremban, Negeri Sembilan, Malaysia		

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

SEMICONDUCTOR PACKAGE AND METHOD THEREFOR

Attorney Docket No. ONS01685

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to Issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

PATENT REEL: 045440 FRAME: 0218

ASSIGNMENT & AGREEMENT ONS01685

By (inventor signature):	(h)
	Chee Hiong CHEW
Witnessed by (Witness sig	gnature):
Printed name of Witness:	AZHAR ARIPIN
Signed and Witnessed on	(date): 3 Dec 2014

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By (Inventor signature):		7		
	pol PRAJUCKAM	OL C	<u></u>	
Witnessed by (Witness signat	ure):		£	
Printed name of Witness:	A2HA7	2 ARIP	rN .	
Signed and Witnessed on Idat	e). 2	Dec 201.	4	

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By (Inventor signature):	\$16 J. 2	<u>ي</u> .		
¥	ushuang YAO		ŷ	
Witnessed by (Witness sign	ature):		min. Committee	
Printed name of Witness: _	AZHAK	AR	(PIN)	 -
Signed and Witnessed on In	ate).	Dec	2014	

PATENT REEL: 045440 FRAME: 0221

RECORDED: 04/04/2018